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"Thermal
analysis of TPX
Superconducting
Magnets"



THERMAL ANALYSIS OF TPX TF COILS

and

CODE VERIFICATION WITH ORNL TRIPLEX

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- Computer code **C/ICC**
- Design of TPX TF coils

Double pancake flow temperature margin

Single pancake flow temperature margin

- Code verification with ORNL NbTi triplex tests

Preliminary results

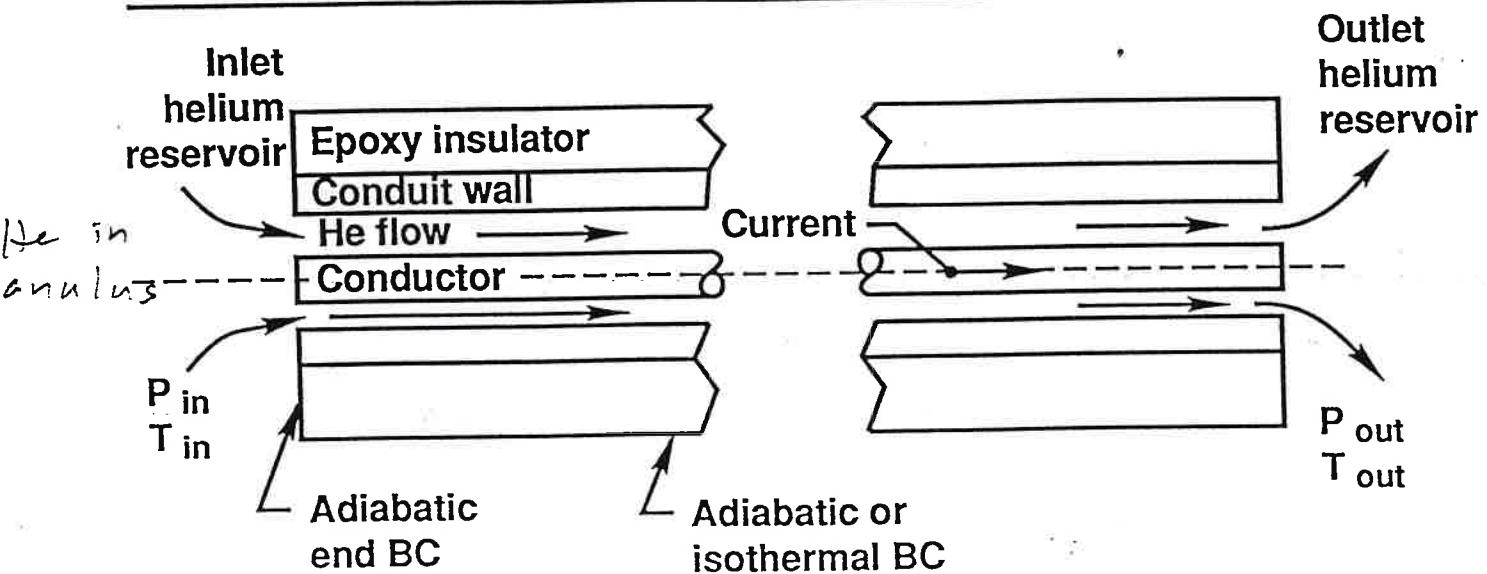
Problems calculating multiple stability

THE COMPUTER CODE C/ICC

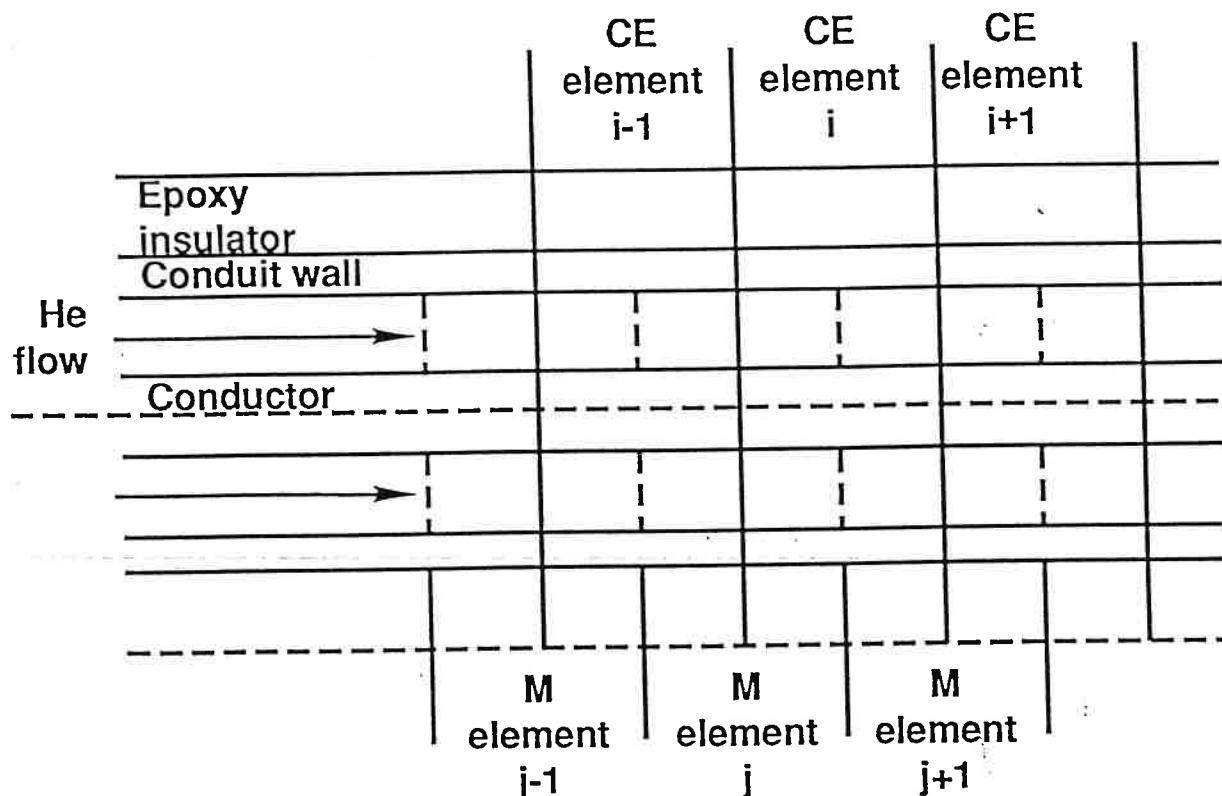
- C/ICC Models Thermo-Fluid Phenomena in Forced-Flow He-Cooled Superconducting Cable-In-Conduit.
 1. The coil length is finite differenced.
 - a. He 1-D pipe flow model
 - b. 2-D axisymmetric solid conduction model
 - c. Cryogenic NBS He properties
 2. The solution in time uses the "method of lines" and an O.D.E. solver.

*DAS > SCL
P&H model*

Forced flow cooled conductor schematic



Staggered grid in section of conductor



Notes:

1. CE element = continuity - energy element
2. M element = momentum element

Conservation equations

Helium momentum equation

$$\frac{\partial(\rho u)}{\partial t} = \frac{\partial}{\partial x} (p + \rho u^2) - \left(\frac{f}{d_h} \right) \left(\frac{1}{2} \rho u |u| \right)$$

Helium continuity equation

$$\frac{\partial \rho}{\partial t} = - \frac{\partial(\rho u)}{\partial x}$$

Helium energy equation

$$\begin{aligned} \left(\frac{\partial}{\partial t} \right) \left[\rho \left(e + \frac{1}{2} u^2 \right) \right] &= - \frac{\partial}{\partial x} \left[(\rho u) \left(h + \frac{1}{2} u^2 \right) \right] \\ &+ \left(\frac{\partial}{\partial x} \right) \left(k \frac{\partial T}{\partial x} \right) + \frac{1}{A_c} \left[\frac{A_{tc}}{R_c} (T_c - T) + \frac{A_{tw}}{R_w} (T_w - T) \right] \end{aligned}$$

Conductor energy equation

$$(\rho_c C_c) \left(\frac{\partial T_c}{\partial x} \right) = - \frac{\partial}{\partial x} \left(f_{Cu} k_{Cu} \frac{\partial T_c}{\partial x} \right) + \frac{1}{A_{cc}} \left[\frac{A_{tc}}{R_c} (T - T_c) \right] + (Q_{gen})$$

Conduit-wall energy equation

$$\begin{aligned} (\rho_w C_w) \left(\frac{\partial T_w}{\partial t} \right) &= \frac{\partial}{\partial x} \left(k_w \frac{\partial T_w}{\partial x} \right) \\ &+ \frac{1}{A_{cw}} \left\{ \frac{A_{tw}}{R_w} (T - T_w) + \frac{(A_{te})_1}{(R_e)_1} [(T_e)_1 - T_w] \right\} \end{aligned}$$

General epoxy layer energy equation

$$\begin{aligned} (\rho_e C_e) \left[\frac{\partial(T_e)_n}{\partial t} \right] &= \frac{\partial}{\partial x} \left\{ k_e \left(\frac{\partial(T_e)_n}{\partial x} \right) \right\} \\ &+ \frac{1}{(A_{ce})_n} \left\{ \frac{(A_{te})_n}{(R_e)_n} [(T_e)_{n-1} - (T_e)_n] + \frac{(A_{te})_{n+1}}{(R_e)_{n+1}} [(T_e)_{n+1} - (T_e)_n] \right\} \end{aligned}$$



TPX TEMPERATURE MARGIN

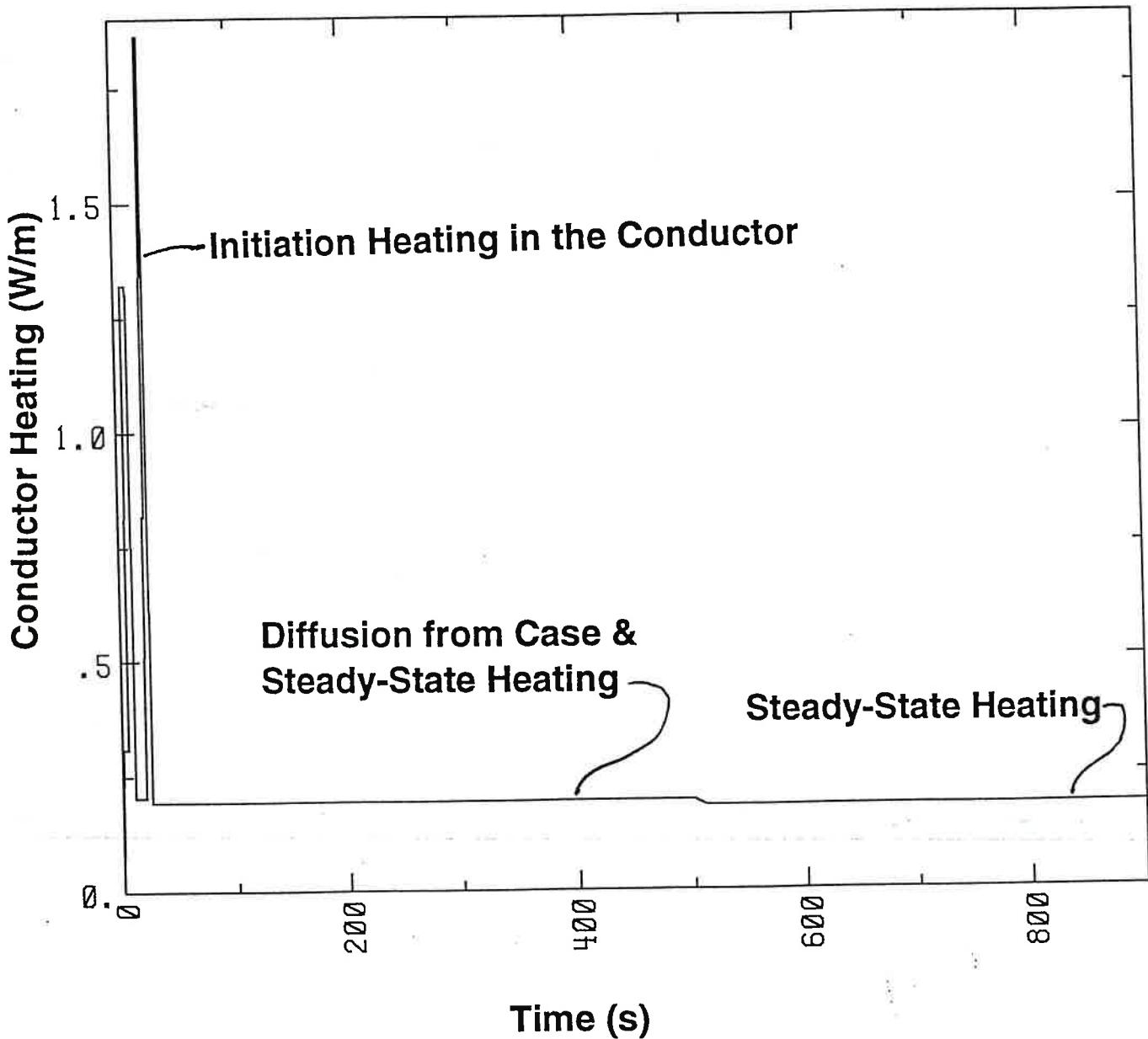
Flat top= 1000 s
Number of TF coils= 16
Turns/pancake= 7
Pancakes= 12
Helium flow rate= 400 g/s (total)
Inlet temperature= 5.0 K
Outlet pressure= 4 atm
Peak field= 7.63 T
Current= 33.5 kA
Current sharing= 7.7 K

DOUBLE AND SINGLE PANCAKE COMPARISON

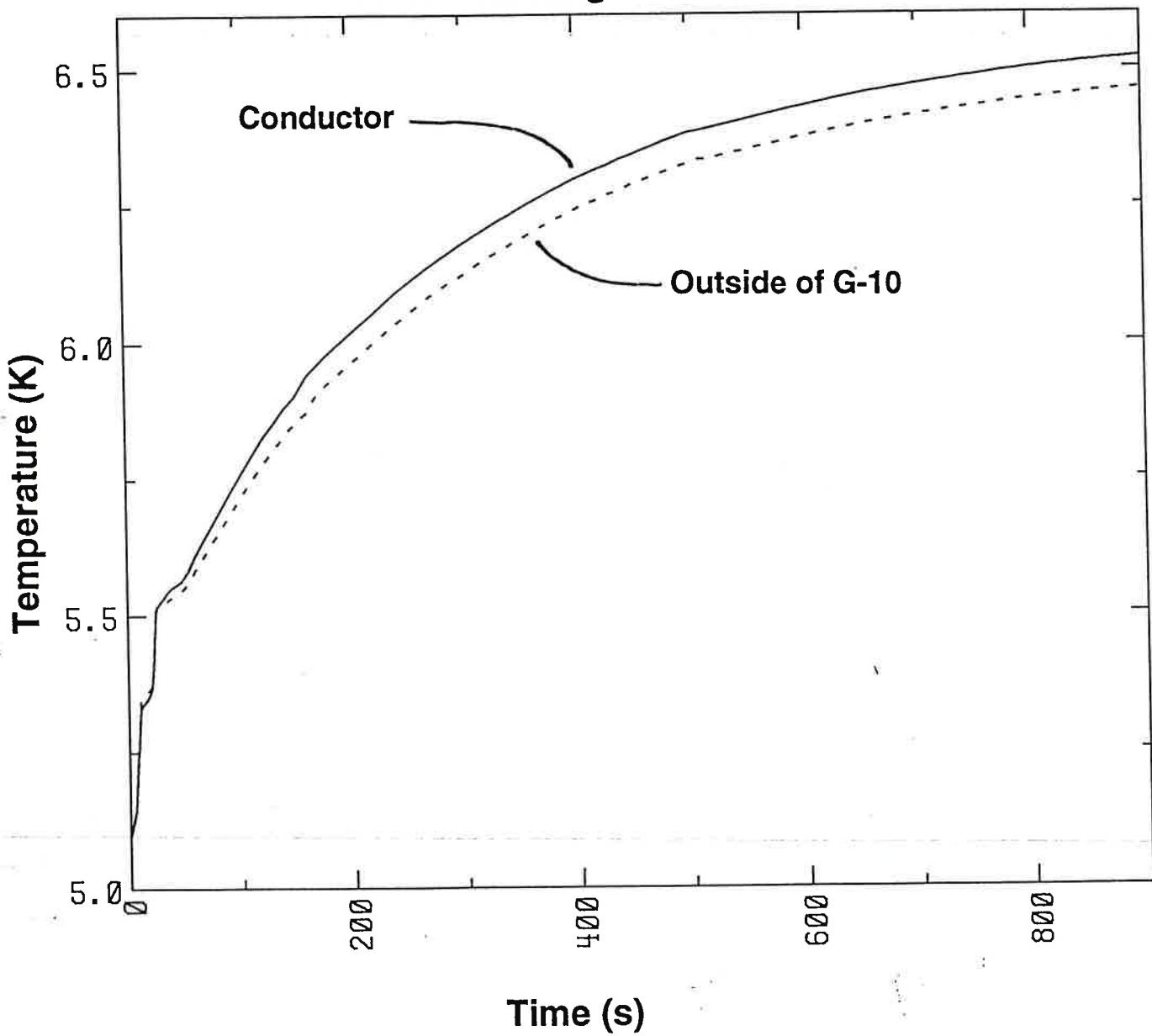
	Max. Bore Temp.	Temp. Margin
Dbl. Pancake	6.5 5.9 K	4.2 1.8 K
Sgl. Pancake	5.9 6.6 K	4.8 0.9 K

Dbl. Pancake Energy Margin= 375 mJ/cc

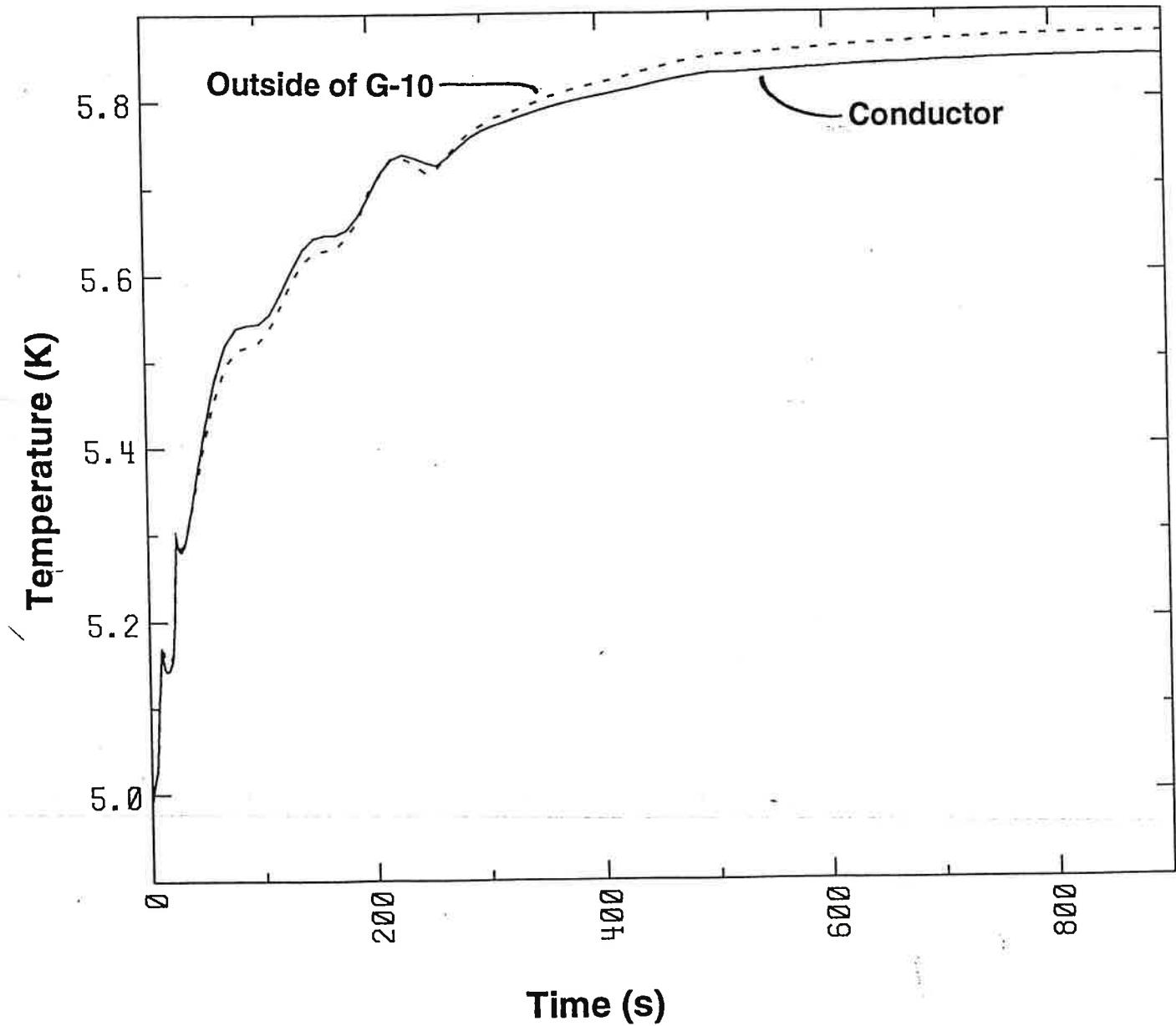
**Fig. 1, Transient Conductor Winding Pack
Heating in Outer Leg at the Bore
Double Pancake Flow Configuration
5 kW Nuclear Heating**



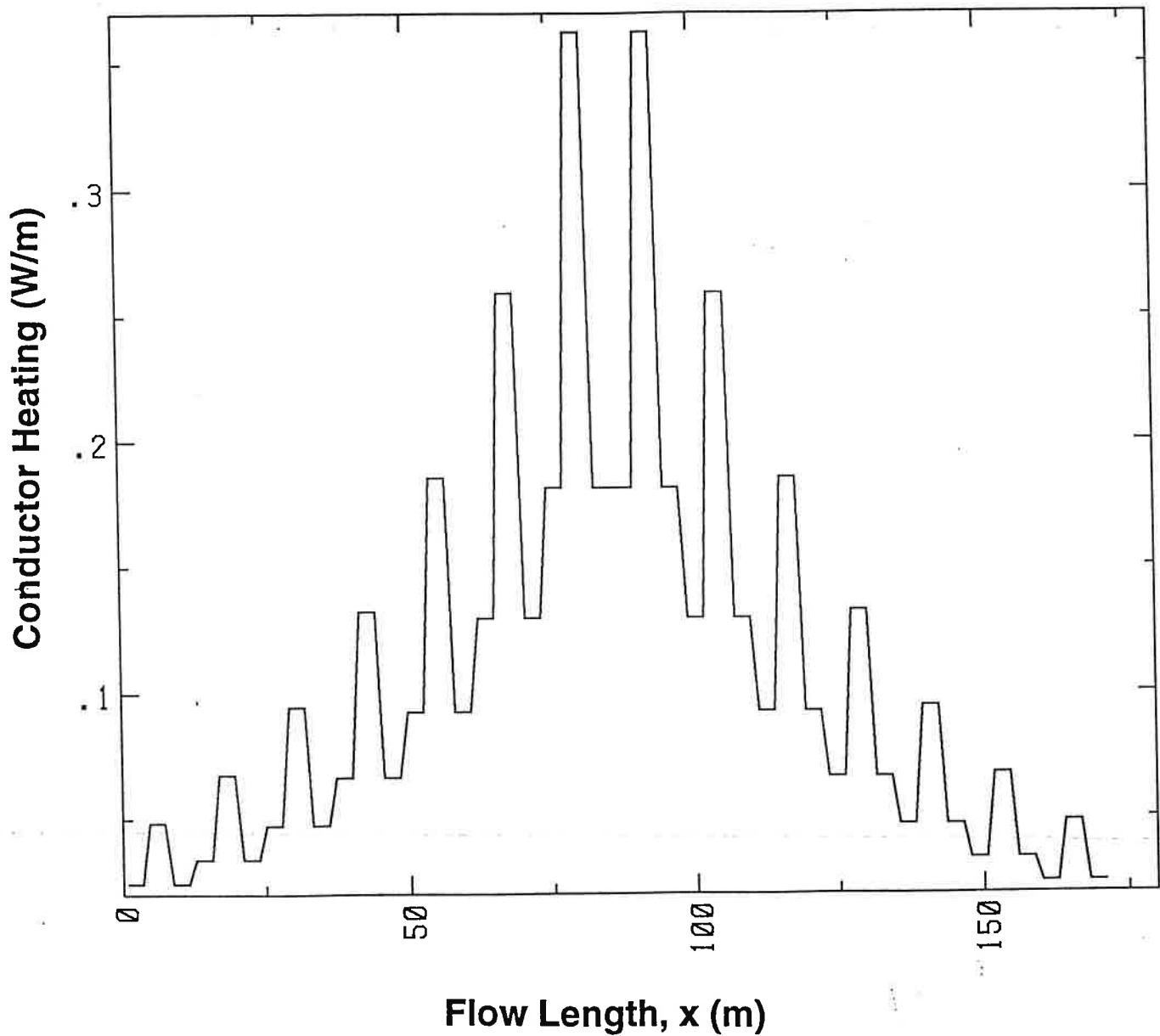
**Fig. 3, Maximum Transient Temperature at Bore
Double Pancake Flow Configuration
5kW Nuclear Heating**



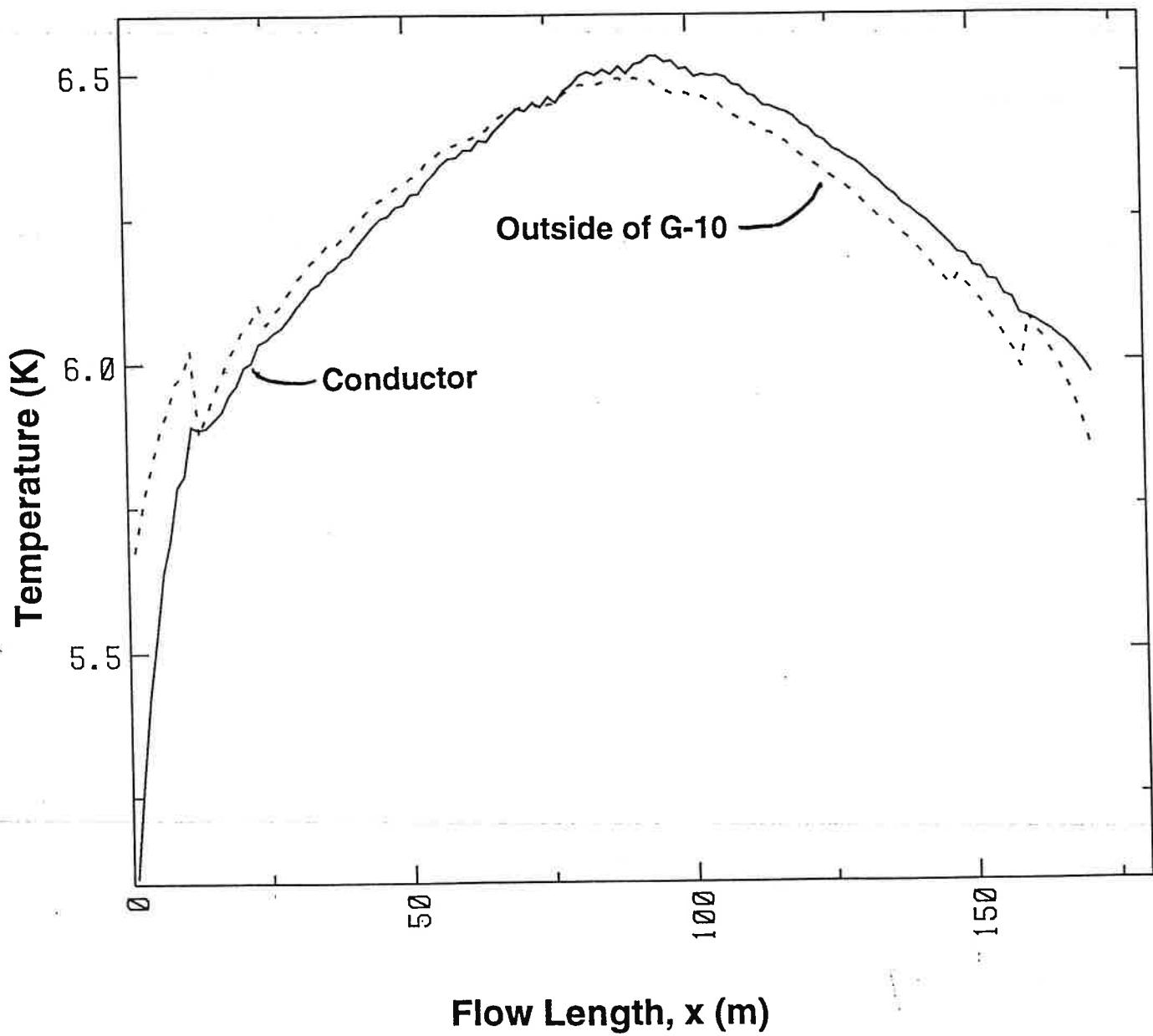
**Fig. 12, Maximum Transient Temperature at Bore
Single Pancake Flow Configuration
5kW Nuclear Heating**



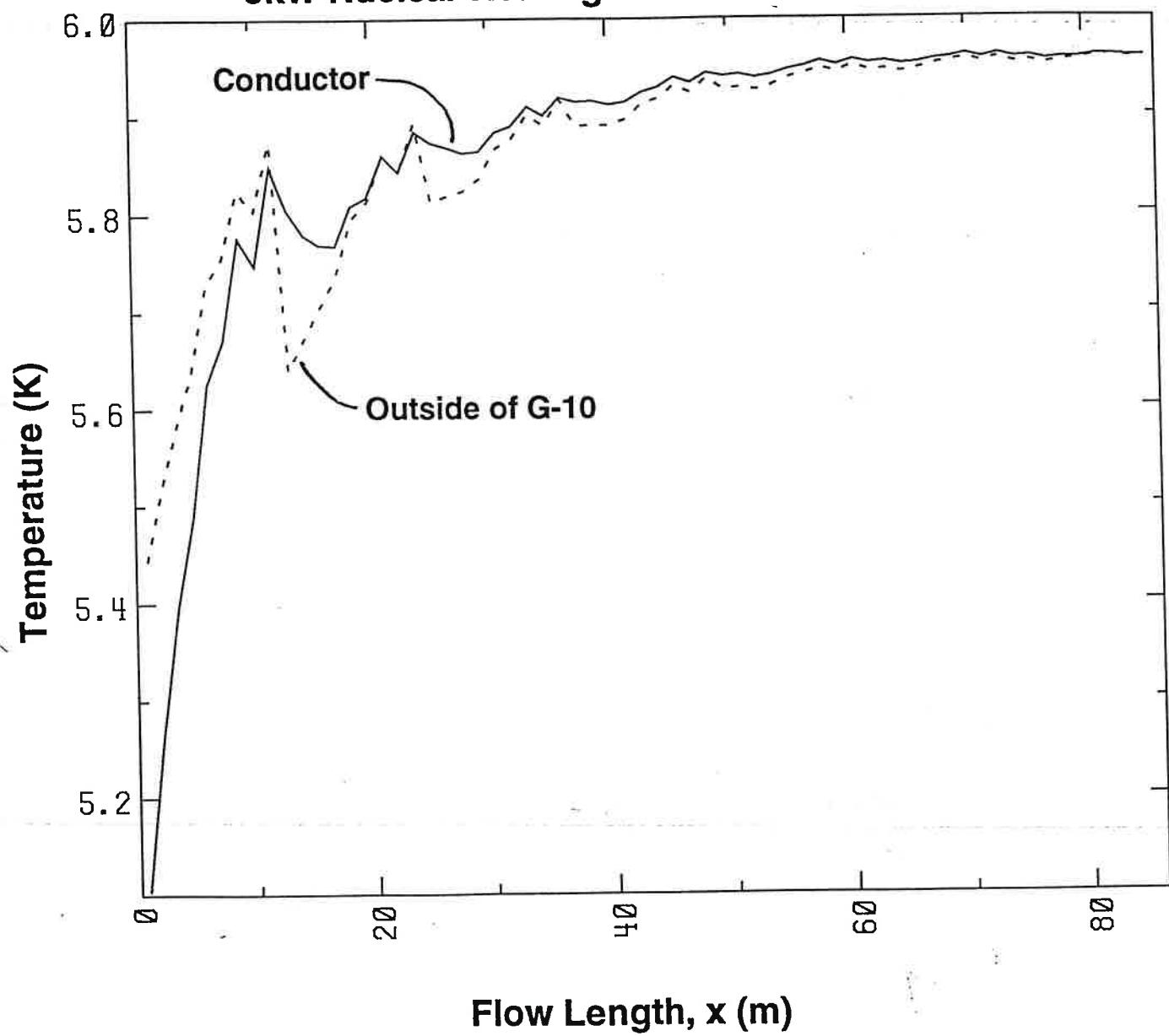
**Fig. 2, Steady-State Conductor Winding Pack Heating Profile
Double Pancake Flow Configuration
5kW Nuclear Heating**



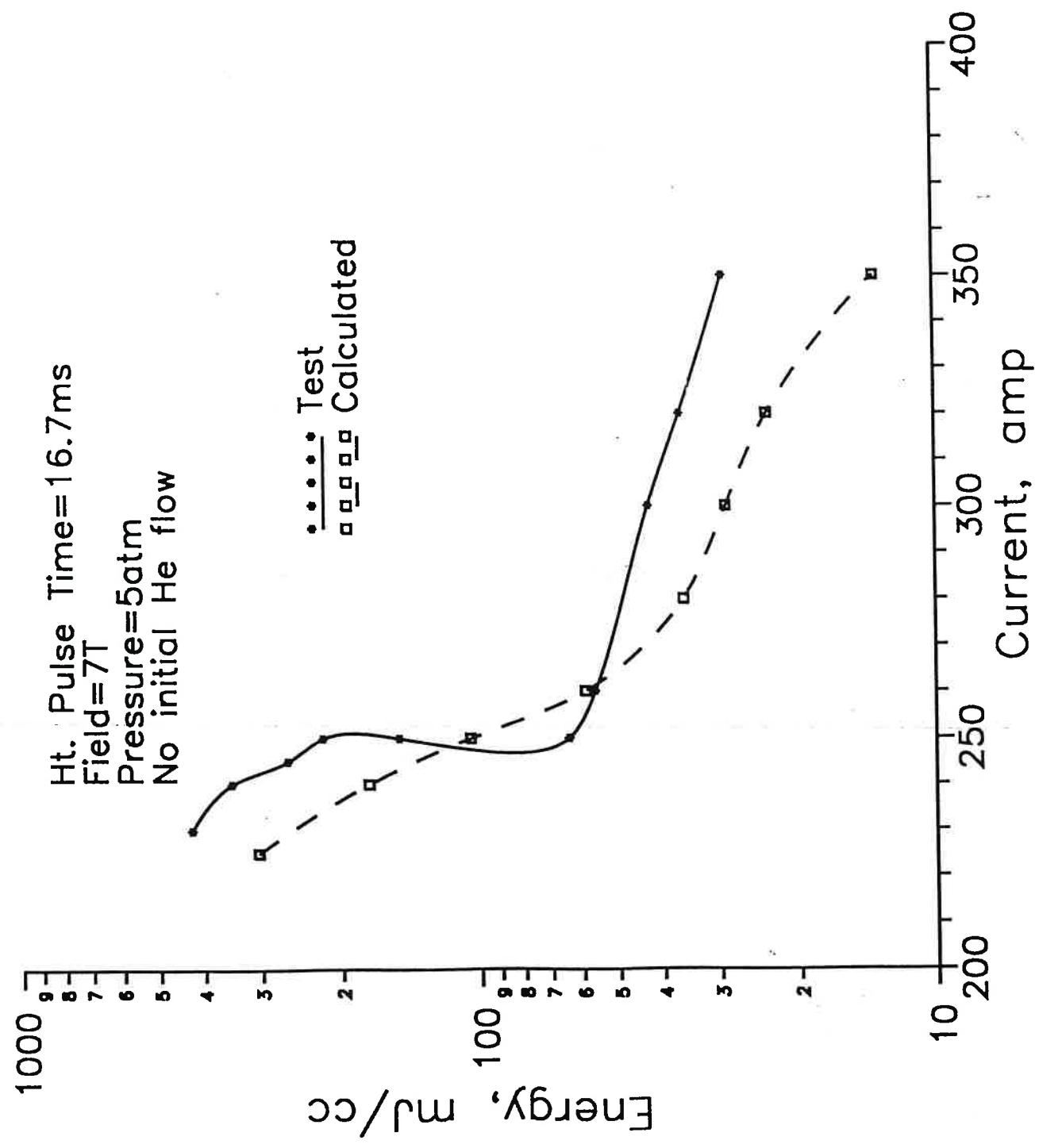
**Fig. 6, Temperature Profile after 900 s
Double Pancake Flow Configuration
5kW Nuclear Heating**



**Fig. 15, Temperature Profile after 900 s
Single Pancake Flow Configuration
5kW Nuclear Heating**

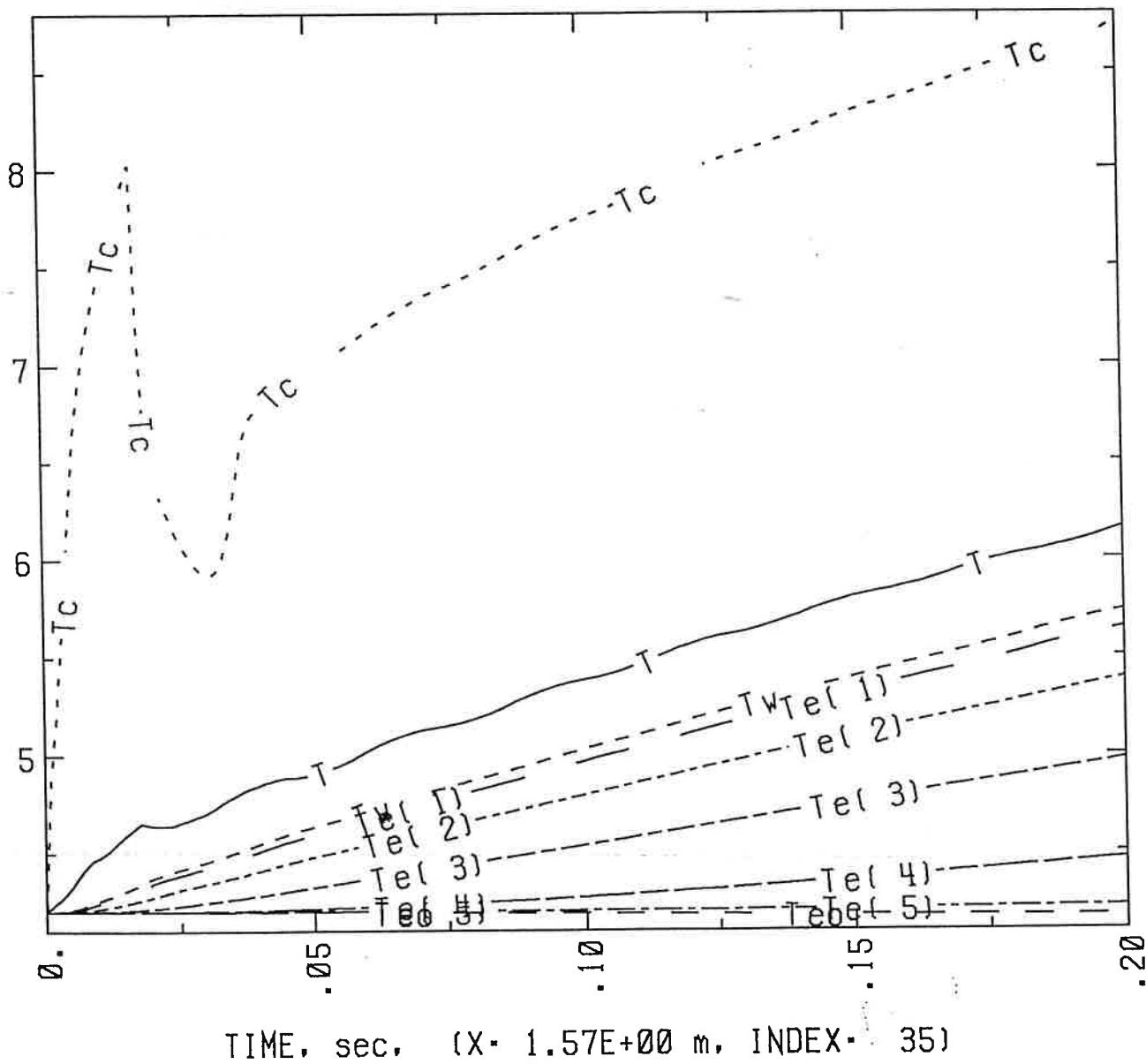


ORNL NbTi TRIPLEX CONDUCTOR STABILITY
3.1m CONDUCTOR LENGTH



ORAC02: 3.1m, 7T, 16.7ms, 250A, 110mJ/cc

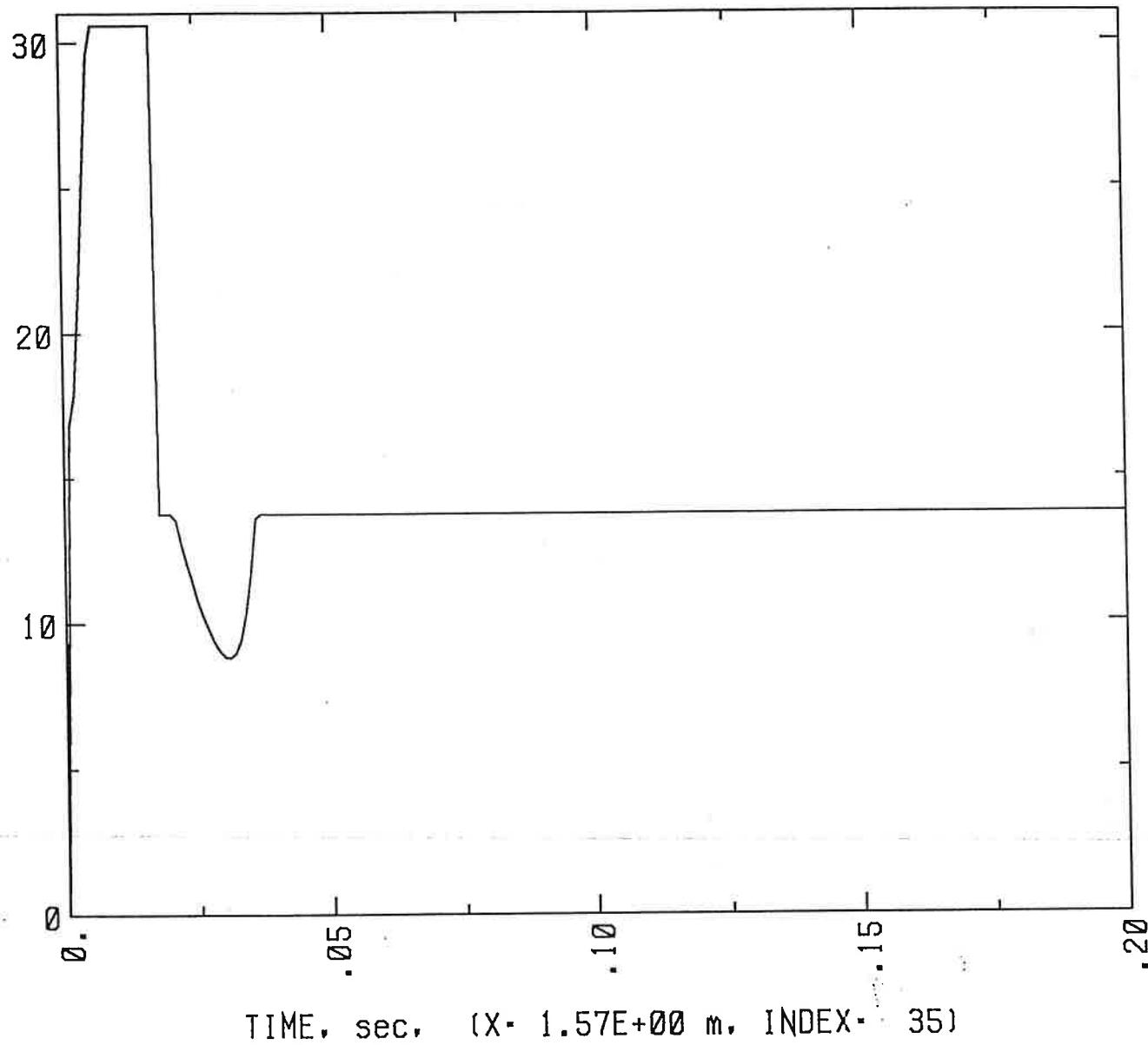
TEMPERATURE, T, Tc, Teo, Te, deg.K



ORAC02: 3.1m, 7T, 16.7ms, 250A, 110mJ/cc

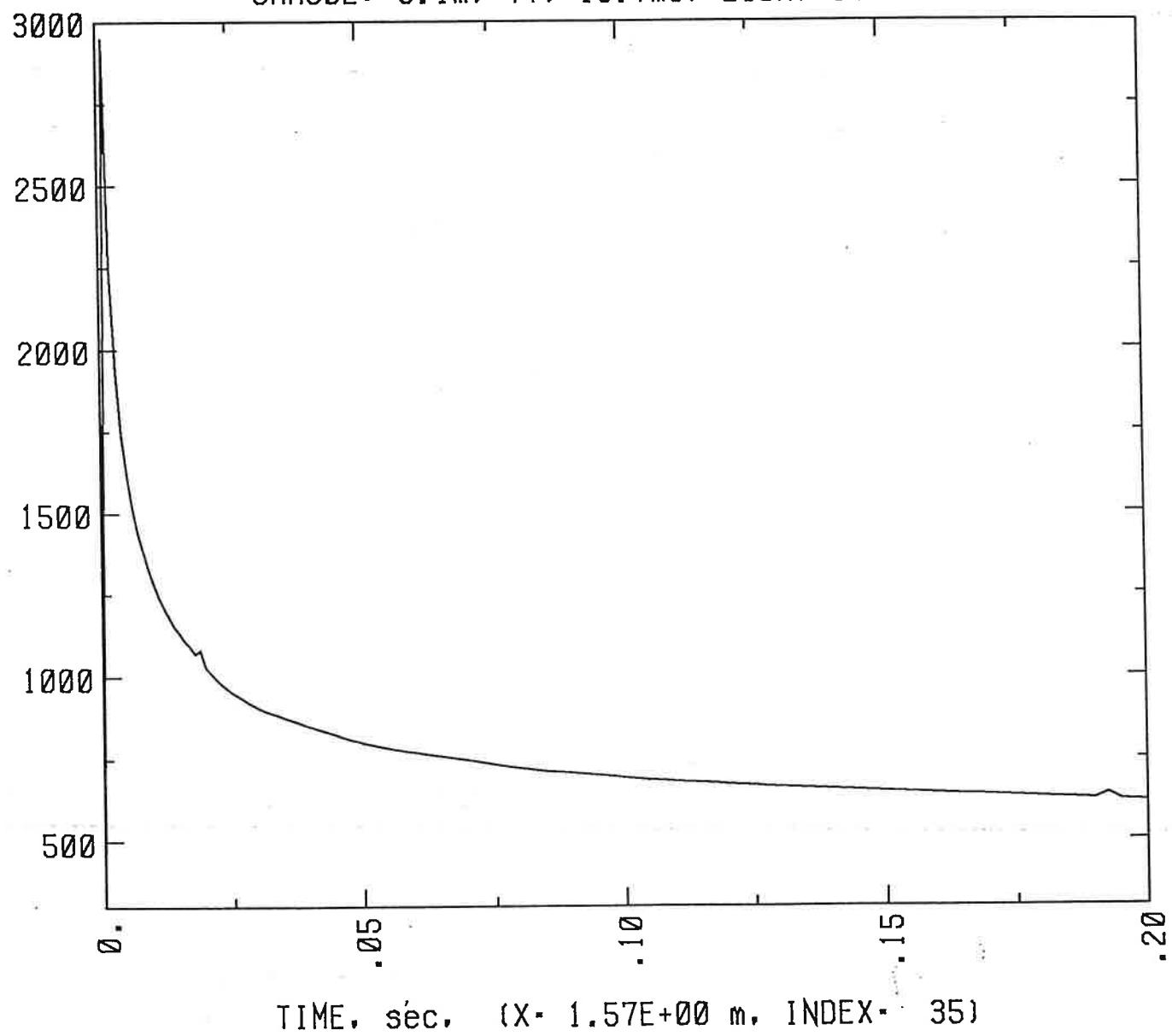
25

CONDUCTOR HEAT GENET ION, Qgenc, W/m



ORAC02: 3.1m, 7T, 16.7ms, 250A, 110mJ/cc

CONDUCTOR H.T. COEF., μTC , $\mu/\text{m} \cdot 2 \text{ deg.K}$



TIME, sec. (X- 1.57E+00 m, INDEX- 35)



QUESTIONS

- **Code is apparently not able to calculate multiple stability with the symmetric flow geometry.**

Multiple stability can be obtained if heating is near one end of conductor.

- **Calculated stability is lower than measured.**

Code results are being compared to FENIX experimental results in current sharing region.